

SP-ULD-GF22FDX-PLUS

Single Port Low Leakage

SRAM Memory Compiler

Ultra-Low Leakage: High V_T (HV_T) and low leakage ($LLHV_T$) devices are used with source biasing to minimize standby currents while operating at low voltage

Bit Cell: Utilizes GlobalFoundries® Ultra-Low Leakage, 6T(L110) bit cells to ensure high manufacturing yields

Five Power Modes: High Performance, Low Leakage, Standby, Retention, and Power Off modes provide flexibility for power optimization

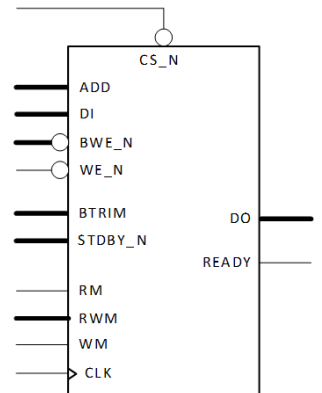
Speed Grades: Three options to adjust the speed/leakage balance and optimize for high speed or low power operation

Memory Ready Output: Create a Pseudo-Dual Port memory utilizing the READY pin

High-Density Solutions: Abutment capability to enable multi-instance macros

Data Write-Through: Optionally prevent data out transitions during a write to reduce power

Error Correction: Optional SECDED logic for single-bit correction and dual bit detection



Technology	GF 22nm FDX PLUS	Max Instance	576Kb	EDA Views (Partial List)	
Voltage	0.65*/0.8V (typical)	Min Instance	256 Bits	Verilog Model with UPF	
Temperature	-40°C to +125°C	Word Width	4 – 144	Liberty Files (NLDM, LVF, CCS)	
Power	Mesh	Banks	1 or 2	PDF and Text Datasheets	Redhawk APL
# Metal Layers	4 (or 5 if enabled)	Word Depth	32 – 8192	LEF 5.8	Verilog Test Bench
Speeds	Slow Medium Fast	Aspect Ratio	Column Fold: 4, 8 or 16	LVS SPICE Netlist	Bitmap File (x, y)
BIST Mux	Internal	Redundancy (CMFOLD 8, 16)	Optional (4 or 8 repairs)	GDS	Power Grid (Votus)
Modes	Functional, BIST, Scan, Sleep	Write Enable	Optional Bit or Byte	Tessent MBIST Control File	Common Power Format (CPF)

*.65 under evaluation

About Nordic Semiconductor:

Located in Seattle, Washington, Nordic Semiconductor Seattle develops SRAM, ROM, and Register File compilers optimized for applications requiring ultra-low power, low leakage, or ultra-high performance. Member of the GF® Partner Community.

<http://www.mobile-semiconductor.com/>

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